

Substitute for form 1449/PTO (Revised 07/2007)  <b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b> <i>(Use as many sheets as necessary)</i>				<b>Complete if Known</b>	
				Application Number	10/599,580
				Filing Date	May 15, 2007
				First Named Inventor	Thoelke
				Art Unit	2194
Examiner Name	Q. Y. Wu				
Sheet	1	of	1	Attorney Docket Number	042933/386066

**U. S. PATENT DOCUMENTS**

Examiner Initials*	Cite No.	Document Number Number - Kind Code (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages of Relevant Figures Appear
		US-			
		US-			

**FOREIGN PATENT DOCUMENTS**

Examiner Initials	Cite No.	Foreign Patent Document Country Code - Number Kind Code (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	English Language Translation Attached
	5	JP 2001-516083 A	09-25-2001		Corresponds to WO 9909490A1 previously cited	
		*Abstract only				

**OTHER DOCUMENTS**

Examiner Initials*	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	English Language Translation Attached
	6	Office Action for Japanese Application No. 2007-505638 dated September 29, 2010	Yes
	7	<del>Ruchman, E. et al., Software Architecture - System of Pattern for Software Development; Published by Kindai Kagakushi Inc., Translated by N. Kanezawa et al., November 30, 2000, pp. 333-337</del>	
	8	<del>Mauro, J. Lecture for Practicing Solaris, Published by IDC Communications Inc., 1 March 1998, Vol. 8, No. 3, pp. 87-93</del>	
Examiner Signature	/Qing Yuan Wu/		Date Considered 03/18/2011

\*Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. LEGAL02/32235108v1

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